## Notice for TAIYO YUDEN products

Please read this notice before using the TAIYO YUDEN products.

#### PREMINDERS

Product information in this catalog is as of October 2014. All of the contents specified herein are subject to change without notice due to technical improvements, etc. Therefore, please check for the latest information carefully before practical application or usage of the Products.

Please note that TAIYO YUDEN CO., LTD. shall not be responsible for any defects in products or equipment incorporating such products, which are caused under the conditions other than those specified in this catalog or individual specification.

- Please contact TAIYO YUDEN CO., LTD. for further details of product specifications as the individual specification is available.
- Please conduct validation and verification of products in actual condition of mounting and operating environment before commercial shipment of the equipment.
- All electronic components or functional modules listed in this catalog are developed, designed and intended for use in general electronics equipment.(for AV, office automation, household, office supply, information service, telecommunications, (such as mobile phone or PC) etc.). Before incorporating the components or devices into any equipment in the field such as transportation,( automotive control, train control, ship control), transportation signal, disaster prevention, medical, public information network (telephone exchange, base station) etc. which may have direct influence to harm or injure a human body, please contact TAIYO YUDEN CO., LTD. for more detail in advance.

Do not incorporate the products into any equipment in fields such as aerospace, aviation, nuclear control, submarine system, military, etc. where higher safety and reliability are especially required.

In addition, even electronic components or functional modules that are used for the general electronic equipment, if the equipment or the electric circuit require high safety or reliability function or performances, a sufficient reliability evaluation check for safety shall be performed before commercial shipment and moreover, due consideration to install a protective circuit is strongly recommended at customer's design stage.

- The contents of this catalog are applicable to the products which are purchased from our sales offices or distributors (so called "TAIYO YUDEN's official sales channel").
  - It is only applicable to the products purchased from any of TAIYO YUDEN's official sales channel.
- Please note that TAIYO YUDEN CO., LTD. shall have no responsibility for any controversies or disputes that may occur in connection with a third party's intellectual property rights and other related rights arising from your usage of products in this catalog. TAIYO YUDEN CO., LTD. grants no license for such rights.
- Caution for export

Certain items in this catalog may require specific procedures for export according to "Foreign Exchange and Foreign Trade Control Law" of Japan, "U.S. Export Administration Regulations", and other applicable regulations. Should you have any question or inquiry on this matter, please contact our sales staff.

### CHIP BEAD INDUCTORS FOR POWER LINES (FB SERIES M TYPE)

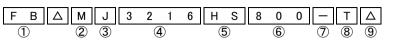


WAVE REFLOV

#### ■PARTS NUMBER

\*Operating Temp. : -40~+125°C (Including self-generated heat)

△=Blank space



①Series name	
Code	Series name
FB	Ferrite bead

2Shape	
Code	Shape
М	Rectangular chip

3 Characteristics						
Code	Characteristics					
J	Standard					
Н	High Impedance type					

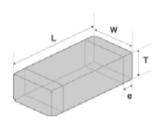
①Dimensions (L × W)								
Code	Type(inch)	Dimensions (L×W)[mm]						
1608	1608 (0603)	1.6 × 0.8						
2125	2125(0805)	2.0 × 1.25						
2012	2012 (0805)	2.0 × 1.25						
2016	2016 (0806)	2.0 × 1.6						
3216	3216(1206)	3.2 × 1.6						
3225	3225(1210)	3.2 × 2.5						
4516	4516(1806)	4.5 × 1.6						
4525	4525 (1810)	4.5 × 2.5						
4532	4532 (1812)	4.5 × 3.2						

# SMaterial Material HS Refer to impedance curves HM for material differences

ance
Nominal impedance[ $\Omega$ ]
33
110
1300

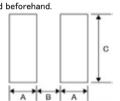
①Impedance tolerance							
Code	Impedance tolerance						
_	±25%						
N	±30%						
®Packaging							
Code	Packaging						
Т	Taping						
③Internal code							
Code	Internal code						
Δ	Standard						

#### ■ STANDARD EXTERNAL DIMENSIONS / STANDARD QUANTITY



Recommended Land Patterns Surface Mounting

 Mounting and soldering conditions should be checked beforehand.



Type	Α	В	С
FB MJ1608	1.0	1.0	1.0
FB MJ2125	1.4	1.2	1.65
FB MJ3216	1.4	2.2	2.0
FB MJ4516	1.75	3.5	2.0
FB MH1608	1.0	1.0	1.0
FB MH2012	1.4	1.2	1.65
FB MH2016	1.4	1.2	2.0
FB MH3216	1.4	2.2	2.0
FB MH3225	1.4	2.2	2.9
FB MH4516	1.75	3.5	2.0
FB MH4525	1.75	3.5	2.9
FB MH4532	1.75	3.5	3.7
			Unit:mm

Time		W	Т		Standard qu	uantity [pcs]
Туре	L	VV	l l	е	Paper tape	Embossed tape
FB MJ1608 (0603)	1.6±0.2 (0.063±0.008)	0.8±0.2 (0.031±0.008)	0.8±0.2 (0.031±0.008)	0.3±0.2 (0.012±0.008)	4000	_
FB MJ2125 (0805)	2.0±0.2 (0.079±0.008)	1.25±0.2 (0.049±0.008)	0.85±0.2 (0.033±0.008)	0.5±0.3 (0.020±0.012)	4000	_
FB MJ3216 (1206)	3.2±0.3 (0.126±0.012)	1.6±0.2 (0.063±0.008)	1.1±0.2 (0.043±0.008)	0.5±0.3 (0.020±0.012)	_	2000
FB MJ4516 (1806)	4.5±0.3 (0.177±0.012)	1.6±0.2 (0.063±0.008)	1.1±0.2 (0.043±0.008)	0.5±0.3 (0.020±0.012)	_	2000
FB MH1608 (0603)	1.6±0.1 (0.063±0.004)	0.8±0.1 (0.031±0.004)	0.8±0.1 (0.031±0.004)	0.3±0.15 (0.012±0.006)	4000	_
FB MH2012 (0805)	2.0±0.2 (0.079±0.008)	1.25±0.2 (0.049±0.008)	0.85±0.2 (0.033±0.008)	0.5±0.3 (0.020±0.012)	4000	_
FB MH2016 (0806)	2.0±0.2 (0.079±0.008)	1.6±0.2 (0.063±0.008)	1.6±0.2 (0.063±0.008)	0.5±0.3 (0.020±0.012)	_	2000
FB MH3216 (1206)	3.2±0.3 (0.126±0.012)	1.6±0.2 (0.063±0.008)	1.6±0.2 (0.063±0.008)	0.5±0.3 (0.020±0.012)	_	2000
FB MH3225 (1210)	3.2±0.3 (0.126±0.012)	2.5±0.3 (0.098±0.012)	2.5±0.3 (0.098±0.012)	0.5±0.3 (0.020±0.012)	_	1000
FB MH4516 (1806)	4.5±0.3 (0.177±0.012)	1.6±0.2 (0.063±0.008)	1.6±0.2 (0.063±0.008)	0.5±0.3 (0.020±0.012)	_	2000
FB MH4525 (1810)	4.5±0.4 (0.177±0.016)	2.5±0.3 (0.098±0.012)	2.5±0.3 (0.098±0.012)	0.9±0.6 (0.035±0.024)	_	1000
FB MH4532 (1812)	4.5±0.4 (0.177±0.016)	3.2±0.3 (0.126±0.012)	3.2±0.3 (0.126±0.012)	0.9±0.6 (0.035±0.024)	_	2000
	•	•			•	H-it(i)

Unit:mm(inch)

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FB MJ1608HM230NT

RoHS

23

#### Standard type FB MJ1608

♥1 B INC 1000								
Parts number	EHS	Nominal impedance (Ω)	Impedance tolerance	Measuring frequency [MHz]	DC Resistance [Ω](max.)	Rated current [A] (max.)	Thickness [mm]	
FB MJ1608HS280NT	RoHS	28	±30%	100	0.007	4.0	0.8 ±0.2	

100

0.007

4.0

0.8 ±0.2

±30%

#### ●FB MJ2125

Parts number	EHS	Nominal impedance (Ω)	Impedance tolerance	Measuring frequency [MHz]	DC Resistance $[\Omega]$ (max.)	Rated current [A] (max.)	Thickness [mm]
FB MJ2125HS250NT	R <sub>0</sub> HS	25	±30%	100	0.004	6.0	0.85 ±0.2
FB MJ2125HS420-T	R <sub>0</sub> HS	42	±25%	100	0.008	4.0	0.85 ±0.2
FB MJ2125HM210NT	RoHS	21	±30%	100	0.004	6.0	0.85 ±0.2
FB MJ2125HM330-T	R <sub>0</sub> HS	33	±25%	100	0.008	4.0	0.85 ±0.2
FB MJ2125HL8R0NT	RoHS	8	±30%	100	0.008	4.0	0.85 ±0.2

#### ●FB MJ3216

Parts number	EHS	Nominal impedance (Ω)	Impedance tolerance	Measuring frequency [MHz]	DC Resistance $[\Omega]$ (max.)	Rated current [A] (max.)	Thickness [mm]
FB MJ3216HS480NT	RoHS	48	±30%	100	0.005	6.0	1.1 ±0.2
FB MJ3216HS800-T	RoHS	80	±25%	100	0.010	4.0	1.1 ±0.2
FB MJ3216HM380NT	RoHS	38	±30%	100	0.005	6.0	1.1 ±0.2
FB MJ3216HM600-T	RoHS	60	±25%	100	0.010	4.0	1.1 ±0.2
FB MJ3216HL160NT	RoHS	16	±30%	100	0.012	4.0	1.1 ±0.2

#### ●FB MJ4516

Parts number	EHS	Nominal impedance $(\Omega)$	Impedance tolerance	Measuring frequency [MHz]	DC Resistance $[\Omega]$ (max.)	Rated current [A] (max.)	Thickness [mm]
FB MJ4516HS720NT	RoHS	72	±30%	100	0.007	6.0	1.1 ±0.2
FB MJ4516HS111-T	RoHS	110	±25%	100	0.014	4.0	1.1 ±0.2
FB MJ4516HM560NT	RoHS	56	±30%	100	0.007	6.0	1.1 ±0.2
FB MJ4516HM900-T	RoHS	90	±25%	100	0.014	4.0	1.1 ±0.2
FB MJ4516HL230NT	R <sub>0</sub> HS	23	±30%	100	0.014	3.5	1.1 ±0.2

#### High impedance type

#### ●FB MH1608

Parts number	EHS	Nominal impedance (Ω)	Impedance tolerance	Measuring frequency [MHz]	DC Resistance [Ω] (max.)	Rated current [A] (max.)	Thickness [mm]
FB MH1608HM470-T	RoHS	47	±25%	100	0.020	3.5	0.8 ±0.1
FB MH1608HM600-T	RoHS	60	±25%	100	0.025	3.0	0.8 ±0.1
FB MH1608HM101-T	RoHS	100	±25%	100	0.035	2.5	0.8 ±0.1
FB MH1608HM151-T	RoHS	150	±25%	100	0.050	2.1	0.8 ±0.1
FB MH1608HM221-T	RoHS	220	±25%	100	0.070	1.8	0.8 ±0.1
FB MH1608HM331-T	RoHS	330	±25%	100	0.130	1.2	0.8 ±0.1
FB MH1608HM471-T	RoHS	470	±25%	100	0.150	1.0	0.8 ±0.1
FB MH1608HM601-T	RoHS	600	±25%	100	0.170	0.9	0.8 ±0.1
FB MH1608HM102-T	RoHS	1000	±25%	100	0.350	0.6	0.8 ±0.1
FB MH1608HL300-T	RoHS	30	±25%	100	0.028	2.6	0.8 ±0.1
FB MH1608HL600-T	RoHS	60	±25%	100	0.045	2.1	0.8 ±0.1
FB MH1608HL121-T	RoHS	120	±25%	100	0.130	1.2	0.8 ±0.1
FB MH1608HL221-T	R <sub>0</sub> HS	220	±25%	100	0.170	0.9	0.8 ±0.1
FB MH1608HL331-T	RoHS	330	±25%	100	0.210	0.8	0.8 ±0.1
FB MH1608HL471-T	RoHS	470	±25%	100	0.350	0.6	0.8 ±0.1
FB MH1608HL601-T	RoHS	600	±25%	100	0.450	0.5	0.8 ±0.1

#### ●FB MH2012

Parts number	EHS	Nominal impedance $(\Omega)$	Impedance tolerance	Measuring frequency [MHz]	DC Resistance [Ω](max.)	Rated current [A] (max.)	Thickness [mm]
FB MH2012HM800-T	RoHS	80	±25%	100	0.025	2.7	0.85 ±0.2
FB MH2012HM121-T	RoHS	120	±25%	100	0.032	2.5	0.85 ±0.2
FB MH2012HM221-T	RoHS	220	±25%	100	0.060	2.0	0.85 ±0.2
FB MH2012HM331-T	RoHS	330	±25%	100	0.080	1.8	0.85 ±0.2

#### FB MH2016

Parts r	number	EHS	Nominal impedance (Ω)	Impedance tolerance	Measuring frequency [MHz]	DC Resistance [Ω](max.)	Rated current [A] (max.)	Thickness [mm]
FB MH2016H	HM121NT	R₀HS	120	±30%	100	0.015	4.5	1.6 ±0.2
FB MH2016H	HM251NT	R₀HS	250	±30%	100	0.050	2.0	1.6 ±0.2

#### FB MH3216

Parts number	EHS	Nominal impedance $(\Omega)$	Impedance tolerance	Measuring frequency [MHz]	DC Resistance $[\Omega]$ (max.)	Rated current [A] (max.)	Thickness [mm]
FB MH3216HM221NT	RoHS	220	±30%	100	0.020	4.0	1.6 ±0.2
FB MH3216HM501NT	RoHS	500	±30%	100	0.070	2.0	1.6 ±0.2

#### ●FB MH3225

Parts number	EHS	Nominal impedance (Ω)	Impedance tolerance	Measuring frequency [MHz]	DC Resistance [Ω](max.)	Rated current [A] (max.)	Thickness [mm]
FB MH3225HM601N	T RoHS	600	±30%	100	0.042	3.0	2.5 ±0.3
FB MH3225HM102N	T RoHS	1000	±30%	100	0.100	2.0	2.5 ±0.3
FB MH3225HM202N	T RoHS	2000	±30%	100	0.130	1.2	2.5 ±0.3

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#### ●FB MH4516

Parts number	EHS	Nominal impedance (Ω)	Impedance tolerance	Measuring frequency [MHz]	DC Resistance $[\Omega]$ (max.)	Rated current [A] (max.)	Thickness [mm]
FB MH4516HM851NT	RoHS	850	±30%	100	0.100	1.5	1.6 ±0.2

#### ●FB MH4525

Parts number	EHS	Nominal impedance (Ω)	Impedance tolerance	Measuring frequency [MHz]	DC Resistance $[\Omega]$ (max.)	Rated current [A] (max.)	Thickness [mm]
FB MH4525HM102NT	RoHS	1000	±30%	100	0.060	3.0	2.5 ±0.3
FB MH4525HM162NT	RoHS	1600	±30%	100	0.130	2.0	2.5 ±0.3

#### FB MH4532

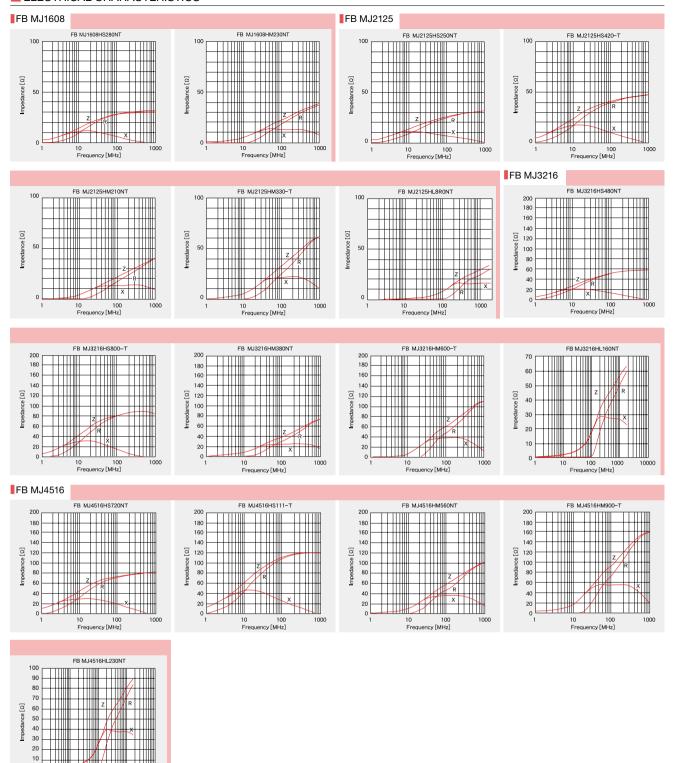
Parts number	EHS	Nominal impedance (Ω)	Impedance tolerance	Measuring frequency [MHz]	DC Resistance $[\Omega]$ (max.)	Rated current [A] (max.)	Thickness [mm]
FB MH4532HM681-T	R₀HS	680	±25%	100	0.028	4.0	$3.2 \pm 0.3$
FB MH4532HM132-T	RoHS	1300	±25%	100	0.060	3.0	3.2 ±0.3
FB MH4532HM202-T	RoHS	2000	±25%	100	0.130	1.3	$3.2 \pm 0.3$

#### High current type

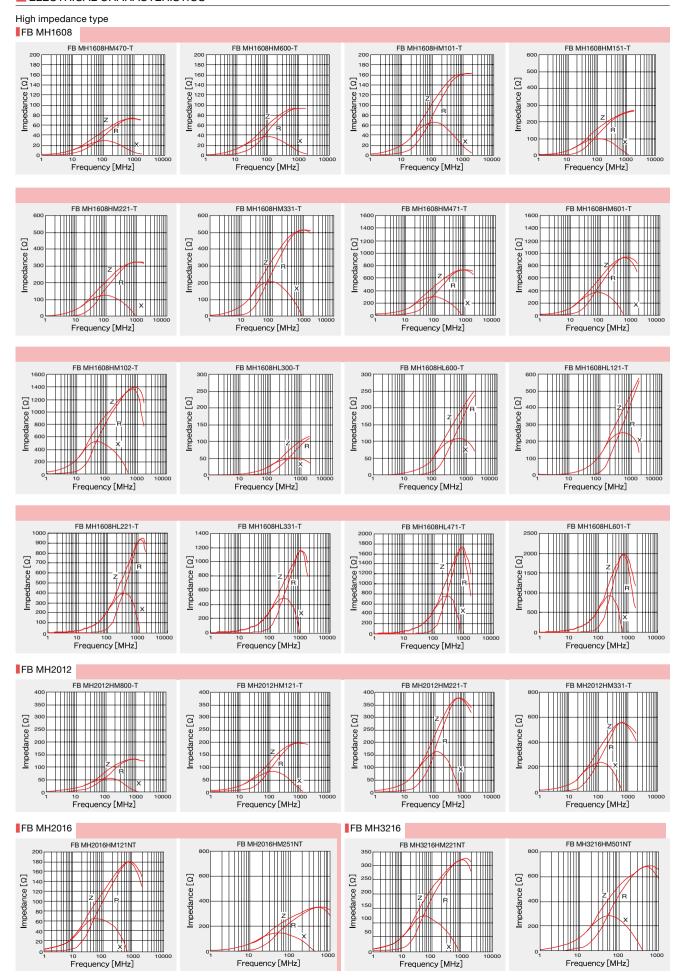
Parts number	EHS	Nominal impedance ( $\Omega$ )	Impedance tolerance	Measuring frequency [MHz]	DC Resistance [Ω](max.)	Rated current [A] (max.)	Thickness [mm]
FB MJ1608HS220NTR	RoHS	22	±30%	100	0.004	7.5	0.8 ±0.2
FB MJ1608HS280NTR	RoHS	28	±30%	100	0.006	6.0	0.8 ±0.2
FB MJ1608HM180NTR	RoHS	18	±30%	100	0.004	7.5	0.8 ±0.2
FB MJ1608HM230NTR	RoHS	23	±30%	100	0.006	6.0	0.8 ±0.2

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100 1000 Frequency [MHz]

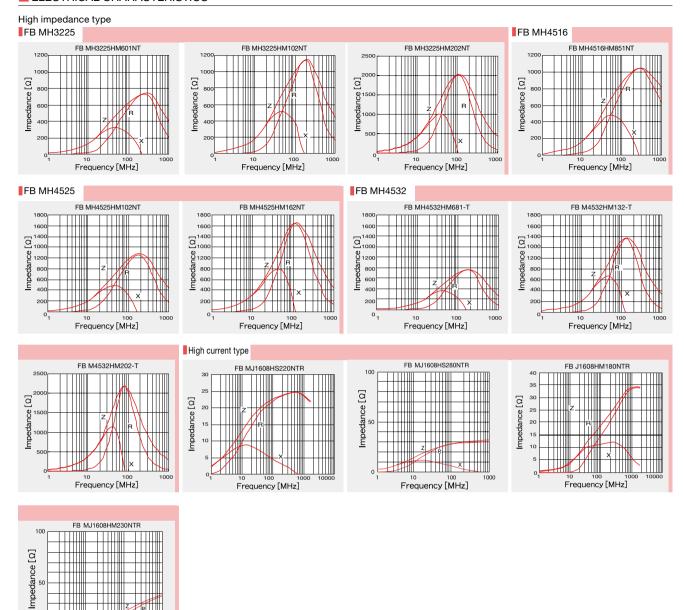


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Frequency [MHz]



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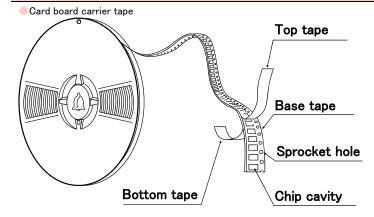
#### CHIP BEAD INDUCTORS FOR POWER LINES (FB SERIES M TYPE)

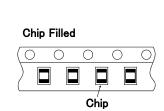
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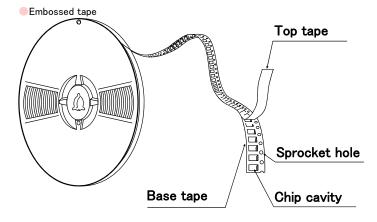
#### 1 Minimum Quantity

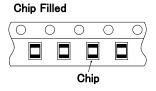
Туре	Standard Qu	uantity[pcs]
туре	Paper Tape	Embossed Tape
1608 (0603)	4000	_
2125(0805)	4000	-
2012 (0805)	4000	_
2016 (0806)	_	2000
3216(1206)	_	2000
3225(1210)	_	1000
4516 (1806)	_	2000
4525(1810)	_	1000
4532(1812)	_	2000

#### 2 Tape Material



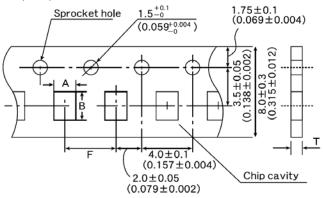






#### 3 Taping Dimensions

Paper tape (0.315 inches wide)

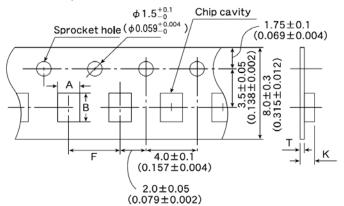


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Type	Chip (	Cavity	Insertion Pitch	Tape Thickness
туре	Α	В	F	Т
FBMJ1608 FBMH1608 (0603)	1.0±0.2 (0.039±0.008)	1.8±0.2 (0.071±0.008)	4.0±0.2 (0.157±0.008)	1.1max (0.043max)
FBMJ2125 FBMH2012 (0805)	1.5±0.2 (0.059±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.2 (0.157±0.008)	1.1max (0.043max)

Unit: mm(inch)

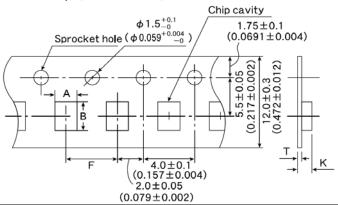
#### Embossed tape (0.315 inches wide)



Туре	Chip Cavity		Insertion Pitch	Tape Ti	nickness
туре	Α	В	F	K	Т
FBMH2016	1.8±0.2	2.2±0.2	4.0±0.2	2.6max	0.6max
(0806)	$(0.071 \pm 0.008)$	$(0.087 \pm 0.008)$	$(0.157 \pm 0.008)$	(0.102max)	(0.024max)
FBMJ3216	1.9±0.2	3.5±0.2	4.0±0.2	1.5max	0.3max
(1206)	$(0.075 \pm 0.008)$	$(0.138 \pm 0.008)$	$(0.157 \pm 0.008)$	(0.059max)	(0.012max)
FBMH3216	1.9±0.2	3.5±0.2	4.0±0.2	2.6max	0.6max
(1206)	$(0.075 \pm 0.008)$	$(0.138 \pm 0.008)$	$(0.157 \pm 0.008)$	(0.102max)	(0.024max)
FBMH3225	2.8±0.2	3.5±0.2	4.0±0.2	4.0max	0.6max
(1210)	$(0.110 \pm 0.008)$	$(0.138 \pm 0.008)$	$(0.157 \pm 0.008)$	(0.157max)	(0.024max)

Unit: mm(inch)

#### Embossed tape (0.472 inches wide)

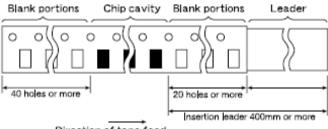


(0.010 ± 0.002)					
т	Chip Cavity		Insertion Pitch	Tape Thickness	
Туре	Α	В	F	K	Т
FBMJ4516	1.9±0.2	4.9±0.2	4.0±0.2	1.5max	0.3max
(1806)	$(0.075 \pm 0.008)$	$(0.193 \pm 0.008)$	$(0.157 \pm 0.008)$	(0.059max)	(0.012max)
FBMH4516	1.9±0.2	4.9±0.2	4.0±0.2	2.6max	0.6max
(1806)	$(0.075 \pm 0.008)$	$(0.193 \pm 0.008)$	$(0.157 \pm 0.008)$	(0.102max)	(0.024max)
FBMH4525	2.9±0.2	4.9±0.2	4.0±0.2	4.0max	0.6max
(1810)	$(0.114 \pm 0.008)$	$(0.193 \pm 0.008)$	$(0.157 \pm 0.008)$	(0.157max)	(0.024max)
FBMH4532	3.6±0.2	4.9±0.2	8.0±0.2	4.0max	0.6max
(1812)	$(0.142 \pm 0.008)$	$(0.193 \pm 0.008)$	$(0.315 \pm 0.008)$	(0.157max)	(0.024max)

Unit: mm(inch)

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#### 4 Leader and Blank portion

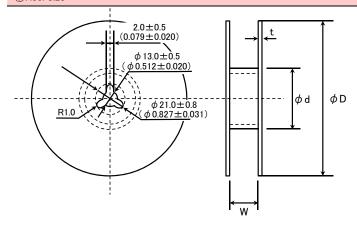


Direction of tape feed

Insertion leader is 400 mm or more (including 20 empty cavities)

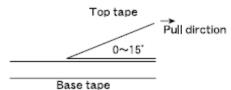
Empty cavities at end of reel: 40 holes or more

#### ⑤Reel size



Туре	$\phi$ D	φd	W	t
FBMJ1608			10.0±1.5	
FBMJ2125			$(0.394 \pm 0.059)$	
FBMJ3216			(0.394 ± 0.039)	
FBMJ4516			14.0±1.5 (0.551±0.059)	
FBMH1608	180+0/-3	60+1/-0		2.5max
FBMH2012	(7.09+0/-0.118)	(2.36+0.039/-0)	10.0±1.5	(0.098max)
FBMH2016			$(0.394 \pm 0.059)$	
FBMH3216			(0.394±0.039)	
FBMH3225				
FBMH4516			14.0±1.5	
FBMH4525			$(0.551 \pm 0.059)$	
FBMH4532	330±2.0	100±1.0	14.0±2.0	3.0max
	$(12.99 \pm 0.080)$	$(3.94 \pm 0.039)$	$(0.551 \pm 0.080)$	(1.181max)
				Unit:mm(inch)

#### **®**Top tape strength



The top tape requires a peel-off force of 0.1 to 0.7N in the direction of the arrow as illustrated below.

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#### CHIP BEAD INDUCTORS FOR POWER LINE (FB SERIES M TYPE)

#### ■RELIABILITY DATA

1. Operating Tempe	rature Range		
Specified Value	-40°C~+125°C Including self-generated heat		
2. Storage Tempera	ture Range		
Specified Value	-40°C∼+85°C		
Test Methods and Remarks	*Note: -5 to +40°C in taped packaging		
3. Impedance			
Specified Value	Within the specified tolerance		
Test Methods and Remarks	Measuring equipment : Impedance analyzer (HP4291A) or its equivalent  Measuring frequency : 100±1 MHz		
4. DC Resistance			
Specified Value	Within the appointed range		
Test Methods and	Within the specified range		
Remarks	Four-terminal method  Measuring equipment : Milliohm High-Tester 3226 (Hioki Denki) or its equivalent		
5. Rated Current			
Specified Value	Within the specified range		
6. Vibration			
Specified Value	Appearance : No significant abnormality Impedance change : Within ±30% of the initial value		
Test Methods and Remarks	According to JIS C 0040.  Vibration type : A  Time : 2 hrs each in X,Y, and Z directions Total: 6 hrs  Frequency range : 10 to 55 to 10Hz (/min.)  Amplitude : 1.5 mm (shall not exceed acceleration 196m/s²)  Mounting method : Soldering onto PC board		
7. Solderability			
Specified Value	90% or more of immersed surface of terminal electrode shall be covered with fresh solder.		
Test Methods and Remarks	Solder temperature $: 230\pm5^{\circ}\text{C}$ Immersion time $: 4\pm1$ sec. Preconditioning $: \text{Immersion into flux.}$ Immersion and Removal speed $: 25\text{mm/sec.}$		
8. Resistance to So			
Specified Value	Appearance : No significant abnormality Impedance change : Within ±30% of the initial value		
Test Methods and Remarks	Preheating : $150^{\circ}$ C for 3 min.  Resistance to Soldering Heat : $260\pm5^{\circ}$ C  Duration : $10\pm0.5$ sec.  Preconditioning : Immersion into flux.  Immersion and Removal speed : $25$ mm/sec.		

Recovery

: 2 to 3 hrs of recovery under the standard condition after the test.

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#### 9. Thermal Shock : No significant abnormality Appearance Specified Value : Within $\pm 50/-10\%$ of the initial value Impedance change According to JIS C 0025. Conditions for 1 cycle Temperature (°C) Duration (min.) Step -40±3°C $30\pm3$ 2 Room Temperature Within 3 Test Methods and 3 85±2℃ 30±3 Remarks 4 Room Temperature Within 3 : 100 Number of cycles : Soldering onto PC board Mounting method Recovery : 2 to 3 hrs of recovery under the standard condition after the removal from test chamber.

10. Resistance to Humidity (steady state)			
Specified Value	Appearances Impedance change	: No significant abnormality : Within $\pm 30\%$ of the initial value	
Test Methods and Remarks	Temperature Humidity Duration Mounting method Recovery	: $40\pm2^{\circ}$ C : 90 to 95% RH : $500+24/-0$ : Soldering onto PC board : 2 to 3 hrs of recovery under the standard condition after the removal from test chamber.	

11. Loading under Damp Heat		
Specified Value	Appearance Impedance change	No significant abnormality Within $\pm 30\%$ of the initial value
Test Methods and Remarks	Temperature Humidity Applied current Duration Mounting method Recovery	: $40\pm2^{\circ}$ C : 90 to 95%RH : Rated current : $500+24/-0$ hrs : Soldering onto PC board : 2 to 3hrs of recovery under the standard condition after the removal from test chamber.

12. High Temperature Loading Test		
Specified Value	Appearance Impedance change	: No significant abnormality : Within $\pm 30\%$ of the initial value
Test Methods and Remarks	Temperature Duration Applied current Mounting method Recovery	: 85±2°C : 500+24/-0 hrs : Rated current : Soldering onto PC board : 2 to 3 hrs of recovery under the standard condition after the removal from test chamber.

13. Bending Strengt	13. Bending Strength		
Specified Value	Appearance : No mechanical damage.		
Test Methods and Remarks	Warp : 2mm Testing board : Glass epoxy-resin substrate Thickness : 0.8mm  Board R-230 Warp  45±2 45±2 (Unit: mm)		

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# Specified Value No separation or indication of separation of electrode. Applied force : 5N Duration : 10 sec. Hooked jig Remarks Board Cross-section

Note on standard condition: "standard condition" referred to herein is defined as follows:

5 to  $35^{\circ}$ C of temperature, 45 to 85% relative humidity and 86 to 106kPa of air pressure.

When there are questions concerning measurement results:

In order to provide correlation data, the test shall be conducted under condition of  $20\pm2^{\circ}\text{C}$  of temperature, 60 to 70% relative humidity and 86 to 106kPa of air pressure. Unless otherwise specified, all the tests are conducted under the "standard condition."

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#### CHIP BEAD INDUCTORS FOR POWER LINE (FB SERIES M TYPE)

#### **PRECAUTIONS**

#### 1. Circuit Design

Precautions

#### ◆Operating environment

# 1. The products described in this specification are intended for use in general electronic equipment, (office supply equipment, telecommunications systems, measuring equipment, and household equipment). They are not intended for use in mission-critical equipment or systems requiring special quality and high reliability (traffic systems, safety equipment, aerospace systems, nuclear control systems and medical equipment including life-support systems,) where product failure might result in loss of life, injury or damage. For such uses, contact TAIYO YUDEN Sales Department in advance.

#### ♠Rated current

1. Rated current of this product is shown in this catalogue, but please be sure to have the base board designed with adequate inspection in case of the generation of heat becomes high within the rated current range when the base board is in high resistance or in bad heating conditions

#### 2. PCB Design

Precautions

◆Land pattern design

1. Please refer to a recommended land pattern.

#### 3. Considerations for automatic placement

Precautions

- ◆Adjustment of mounting machine
- 1. Excessive impact load should not be imposed on the products when mounting onto the PC boards.
- 2. Mounting and soldering conditions should be checked beforehand.

Technical considerations

- ◆Adjustment of mounting machine
  - 1. When installing products, care should be taken not to apply distortion stress as it may deform the products.

#### 4. Soldering

#### ◆Wave soldering

- 1. Please refer to the specifications in the catalog for a wave soldering
- ◆Reflow soldering
  - 1. Please contact any of our offices for a reflow soldering, and refer to the recommended condition specified.
- **♦**Lead free soldering
  - 1. When using products with lead free soldering, we request to use them after confirming adhesion, temperature of resistance to soldering heat, etc. sufficiently.

#### Precautions

◆Preheating when soldering

 $Heating: The \ temperature \ difference \ between \ soldering \ and \ remaining \ heat \ should \ not \ be \ greater \ than \ 150^{\circ}C.$ 

Cooling: The temperature difference between the components and cleaning process should not be greater than 100°C.

◆Recommended conditions for using a soldering iron

Put the soldering iron on the land-pattern.

Soldering iron's temperature - Below 350°C

Duration - 3 seconds or less

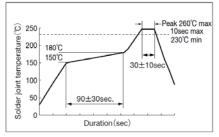
The soldering iron should not directly touch the inductor.

#### ◆Wave, Reflow, Lead free soldering

1. If products are used beyond the range of the recommended conditions, heat stresses may deform the products, and consequently degrade the reliability of the products.

[Recommended reflow condition]

## Technical considerations



#### ◆Preheating when soldering

- 1. There is a case that products get damaged by a heat shock.
- ◆Recommended conditions for using a soldering iron
  - If products are used beyond the range of the recommended conditions, heat stresses may deform the products, and consequently degrade the reliability of the products.

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5. Handling					
	◆Handling  1. Keep the inductors away from all magnets and magnetic objects.				
	♦ Setting PC boards				
	1. When setting a chip mounted base board, please make sure that there is no residual stress to the chip by distortion in the board or at screw part.				
Precautions	◆Breakaway PC boards (splitting along perforations)				
	1. When splitting the PC board after mounting inductors, care should be taken not to give any stresses of deflection or twisting to the board.				
	2. Board separation should not be done manually, but by using the appropriate devices.				
	♦ Mechanical considerations				
	Please do not give the inductors any excessive mechanical shocks.				
	♦Handling				
	1. There is a case that a characteristic varies with magnetic influence.				
	♦ Setting PC boards				
Technical	1. There is a case that a characteristic varies with residual stress.				
considerations	◆Breakaway PC boards (splitting along perforations)				
	1. Planning pattern configurations and the position of products should be carefully performed to minimize stress.				
	◆Mechanical considerations				
	1. There is a case to be damaged by a mechanical shock.				

6. Storage conditions			
Precautions	<ul> <li>◆Storage</li> <li>1. To maintain the solderability of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled.</li> <li>•Recommended conditions         <ul> <li>Ambient temperature 0~40°C</li> <li>Humidity Below 70% RH</li> </ul> </li> <li>The ambient temperature must be kept below 30°C. Even under ideal storage conditions, solderability of products electrodes may decrease as time passes.</li> <li>For this reason, inductors should be used within 6 months from the time of delivery.</li> </ul>		
Technical considerations	◆Storage 1. Under a high temperature and humidity environment, problems such as reduced solderability caused by oxidation of terminal electrodes and deterioration of taping/packaging materials may take place.		